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SY84782U



Low Power 2.5V 1.25Gbps FP/DFB Laser Diode Driver

General Description

The SY84782U is a single 2.5V supply, ultra-low power, small form factor laser diode driver for telecom/datacom applications. Intended to drive FP/DFB lasers at data rates up to 1.25Gbps, it is especially useful for Compact SFP, SFP, and SFF modules where power requirements are quite stringent. The driver can deliver modulation current up to 90mA and offers a high compliance voltage, all of which make the SY84782U suitable for high current operations in both AC- and DC-coupled applications.

The SY84782U is intended to be used with Micrel's MIC3003 Optical Transceiver Management IC, which allows for both modulation and bias current control and monitoring. Furthermore, the MIC3003 offers power control and temperature compensation.

This device operates across the industrial temperature range (-40° C to $+95^{\circ}$ C) and is available in a small 3mm × 3mm QFN package.

All datasheets and support documentation can be found on Micrel's website at: www.micrel.com.

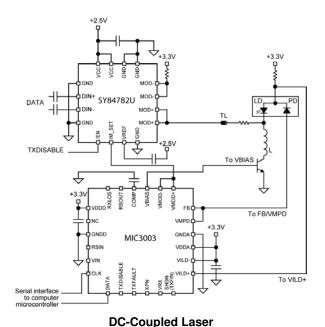
Features

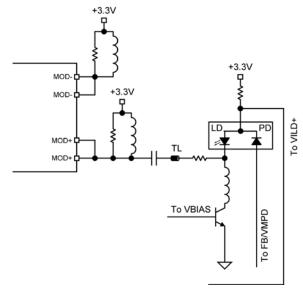
- 2.5V power supply option
- Ultra low power consumption (63mW typ)
- Multirate up to 1.25Gbps
- Fast rise and fall time
- · Modulation current up to 90mA
- Laser can be DC- or AC-coupled
- Small form factor 16-pin (3mm × 3mm) QFN package
- MIC3003G compatible
- Extensive temperature range (-40°C to +95°C)

Applications

- Multirate LAN, MAN applications: Fibre Channel, GbE, SONET OC3/12/24, and SDH STM1/4/8
- CSFP/SFF/SFP optical modules

Typical Application





AC-Coupled Laser

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August 11, 2015 Revision 2.0 hbwhelp@micrel.com or (408) 955-1690

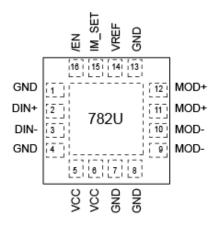
Ordering Information

Part Number	Package Type	ackage Type		Lead Finish	
SY84782UMG	QFN-16	Industrial	782U Pb-Free Bar-Line Indicator	Pb-Free	
SY84782UMG TR ⁽¹⁾	QFN-16	Industrial	782U Pb-Free Bar-Line Indicator	Pb-Free	

Note:

Tape and Reel

Pin Configuration



16-Pin QFN

Pin Description

Pin Number	Pin Name	Pin Function			
1, 4, 7, GND,		Device Ground. Ground and exposed pad must be connected to the plane of the most negative			
8, 13	ePad	potential.			
2	DIN+	Non-Inverting Input Data. Internally terminated with 50Ω to a reference voltage			
3 DIN- Inverting Input Data. Internally terminated with 50Ω to a reference voltage		Inverting Input Data. Internally terminated with 50Ω to a reference voltage			
5, 6	5, 6 VCC Supply Voltage. Bypass with a 0.1μF 0.01μF low-ESR capacitor as close to VCC pin as possible				
9, 10	MOD-	Inverted Modulation Current Output. Provides modulation current when input data is negative			
11, 12	MOD+	Non-Inverted Modulation Current Output. Provides modulation current when input data is positive.			
14	VREF	Reference Voltage. Install a 0.1µF capacitor between VREF and VCC			
15	IM_SET	Modulation current setting and control. The voltage applied to this pin will set the modulation current. To be connected to the MIC3003 Pin 24 (VMOD+). Input impedance $25k\Omega$.			
16	/EN	Enable Pin. A high level signal applied to this pin will pull the MOD+ output HIGH and MOD- output LOW. Internally pulled down with a $75k\Omega$ resistor.			

Truth Table

DIN+	DIN-	/EN	MOD+ ⁽²⁾	MOD-	Laser Output (3)	
L	Н	L	Н	L	L	
Н	L	L	L	Н	Н	
Х	Х	Н	Н	L	L	

Notes:

2. $I_{MOD} = 0$ when MOD + = H.

Assuming that laser is tied to MOD+.

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Absolute Maximum Ratings⁽⁴⁾

Supply Voltage (V_{CC})-0.5V to +3.0V Input Voltage (V_{IN})-0.5V to V_{CC} TTL Control Input Voltage (V_{IN}) 0V to V_{CC} Lead Temperature (soldering, 20s).....+260°C Storage Temperature (T_S)-65°C to +150°C

Operating Ratings⁽⁵⁾

Supply Voltage (V _{CC})	2.375V to 2.625V
Ambient Temperature (T _A)	40°C to +95°C
Package Thermal Resistance ⁽⁶⁾	
Still-Air (θ _{JA})	60°C/W
Junction-to-Board (Ψ _{IR})	33°C/W

DC Electrical Characteristics⁽⁷⁾

 V_{CC} = 2.5V ±5%, T_A = -40°C to +95°C. Typical values are V_{CC} = 2.5V, T_A = 25°C, I_{MOD} = 60mA.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
Icc	Power Supply Current	Modulation current excluded		24	30 ⁽⁸⁾	mA
V _{MOD_MIN}	Minimum voltage required at driver output for proper operation		0.6			V
R _{iIN(DATA)}	Input Resistance (DIN+, DIN-)		45	50	55	Ω
R _{iIN(IMOD_SET)}	Input Resistance (IM_SET)			25		kΩ
V _{ID}	Differential Input Voltage Swing		200		2400	mVpp
V _{IH_EN}	/EN Input High		2			V
V _{IL_EN}	/EN Input Low				0.8	V
V _{IM_SET}	Voltage Range on IM_SET Pin	I _{MOD} range 10mA – 90mA			1.2	V

AC Electrical Characteristics⁽⁷⁾

 $V_{CC} = 2.5V \pm 5\%$, $T_A = -40$ °C to +95°C. Typical values are $V_{CC} = 2.5V$, $T_A = 25$ °C, $I_{MOD} = 60$ mA.

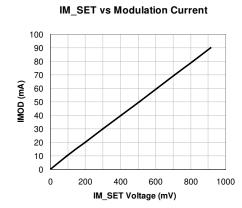
Symbol	Parameter	Condition	Min.	Тур.	Max.	Units	
	Data Rate	NRZ Data	0.155		1.25	Gbps	
I _{MOD}	Modulation Current	AC-Coupled	10		90	mA	
	(15Ω Load)	DC-Coupled	10		70 ⁽⁹⁾		
I _{MOD_OFF}	Modulation OFF current	Current at MOD+ when the device is disabled			750	μΑ	
	Total Jitter	@ 1.25Gbps data rate			20	pspp	
	Pulse-Width Distortion	I _{MOD} range 10mA – 90mA			20	ps	
t _r , t _f	Output Rise/Fall Times (20% to 80%)	15Ω Load		100	140	ps	

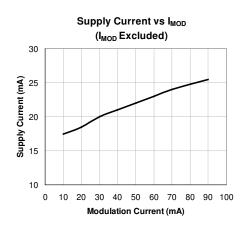
Notes:

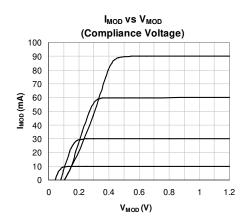
- Exceeding the absolute maximum rating may damage the device.
- The device is not guaranteed to function outside its operating rating.
- Package thermal resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB.
- 7. Specification for packaged product only.
- Icc = 30mA (excluding I_{MOD}) for worst case conditions with V_{CC} = 2.625V, T_A = 85°C, I_{MOD} = 60mA.
- Assuming V_{CC} = 2.375V, laser band gap voltage = 1V, laser package inductance = 1nH, laser equivalent series resistor = 5Ω, and damping resistor = 100

Typical Operating Characteristics

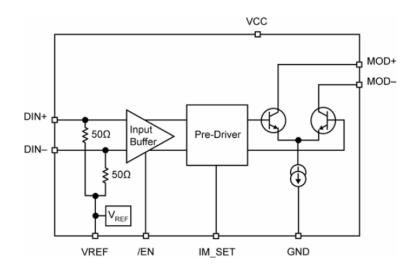
 $V_{CC} = 2.5 V \pm 5\%$, $T_A = -40 ^{\circ} C$ to $+95 ^{\circ} C$. Typical values are $V_{CC} = 2.5 V$, $T_A = 25 ^{\circ} C$, $I_{MOD} = 60 mA$.





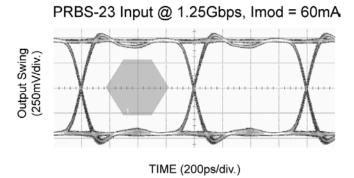


Functional Block Diagram

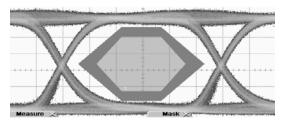


Functional Characteristics

 $V_{CC} = 2.5V \pm 5\%$, $T_A = -40$ °C to +95°C. Typical values are $V_{CC} = 2.5V$, $T_A = 25$ °C, $I_{MOD} = 60$ mA.



PRBS-23 Input @ 1.25Gbps, Optical



TIME (134ps/div.) ER = 11dB, 50% Eye Margin

Input and Output Stages

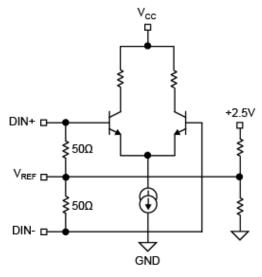


Figure 1. Simplified Input Stage

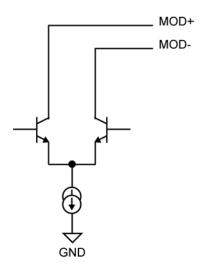


Figure 2. Simplified Output Stage

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Application Information

The typical applications diagram on the first page shows how to connect the driver to the laser single-ended. To improve transition time and laser response, the laser can be driven differentially, as shown in Figures 3 and 4. Driving the laser differentially will also minimize crosstalk with the rest of the circuitry on the board, particularly the receiver.

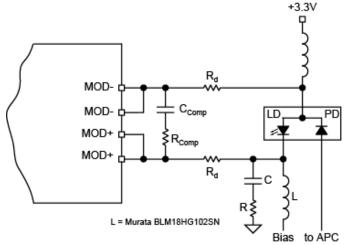
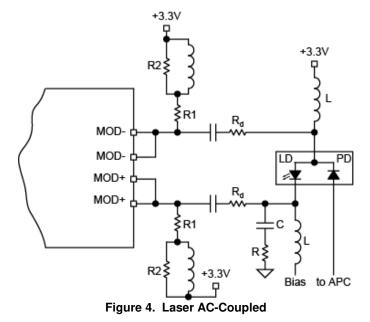


Figure 3. Laser DC-Coupled



DC-Coupling

In addition to the low power consumption and high modulation current, the SY84782U offers a high compliance voltage. The minimum voltage needed at the output of the driver for proper operation is less than 600mV, leaving a large headroom, V_{CC} - 600mV, to the laser with the damping resistor. To show the importance of this high compliance voltage, consider the voltage drops along the path from V_{CC} to ground through the laser, damping resistor, and driver:

> V_{CC} = Driver Headroom + V_{Rd} + V_{laser} $V_{Rd} = Rd \times I_{MOD}$ $V_{laser} = V_{band-qap} + R_{laser} \times I_{MOD} + Ldi/dt$ $V_{band-gap} + R_{laser} \times I_{MOD} = 1.6V$ at maximum for a Fabry Perrot or a DFB laser.

Ldi/dt is the voltage drop due to the laser parasitic inductance during I_{MOD} transitions. Assuming L = 1nH, t_f = t_f = 80ps (measured between 20% and 80% of I_{MOD}), and $I_{MOD} = 70$ mA (42mA from 20% to 80%), then Ldi/dt will be equal to 525mV. This number can be minimized by making the laser leads as short as possible and by using the RC compensation network between the cathode of the laser and ground or across the laser driver outputs, as shown in Figure 3.

To be able to drive the laser DC-coupled with a high current, it is necessary to keep the damping resistor as small as possible. For example, if the drop due to parasitic inductance of the laser is neglected (compensated for) and the maximum drop across the laser (1.6V) considered while keeping a minimum of 600mV headroom for the driver, then the maximum damping resistor that allows a 70mA modulation current into the laser is:

> $R_{dmax} = (V_{CC}-0.6V-1.6V)/0.07A$ The worst case will be with $V_{CC} = 3.0V$, leading to $R_{dmax} = 11.4\Omega$

On the other hand, the smaller the value of R_d , the higher is the overshoot/undershoot on the optical signal from the laser. In the circuit shown in Figure 4, the RC compensation network across the driver outputs (MOD+ and MOD-) allows the user $R_d=10\Omega.$ The optical eye diagrams at data rates of 1.25Gbps, shown in "Functional Characteristics" section, are all obtained with the same circuit using $R_d=10\Omega,\,R_{Comp}=100\Omega,$ and $C_{Comp}=3pF.$ The compensation network may change from one board to another and from one type of laser to another. An additional compensation network (RC) can be added at the laser cathode for further compensation and eye smoothing.

AC-Coupling

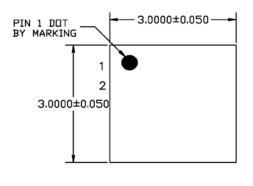
When trying to AC-couple the laser to the driver, the headroom of the driver is no longer a problem since it is DC isolated from the laser with the coupling capacitor. At the output, the headroom of the driver is determined by the pull-up network. In Figure 4, the modulation current out of the driver is split between the pull-up network and the laser. If, for example, the total pull-up resistor is twice the sum of the damping resistor and laser equivalent series resistance, then only two thirds (2/3) of the modulation current will be used by the laser. Therefore, to keep most of the modulation current going through the laser, the total pull-up resistor must be kept as high as possible. One solution involves using an inductor alone as pull-up, presenting a high impedance path for the modulation current and zero ohm (0Ω) path for the DC current offering headroom of the driver equal to V_{CC} and almost all the modulation current goes into the laser. The inductor alone will cause signal distortion, and, to improve this phenomenon, a combination of resistors and inductors can be used (as shown on Figure 4). In this case, the headroom of the driver is V_{CC}-R1 x αI_{MOD} , where αI_{MOD} is the portion of the modulation current that goes through the pull-up network.

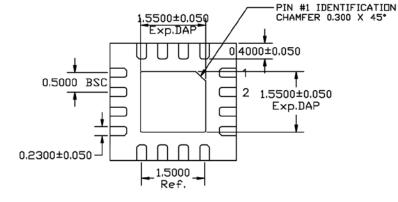
When the laser is AC-coupled to the driver, the coupling capacitor creates a low-frequency cutoff in the circuit, and its value must be chosen to be as large as possible. If the value of the cap is too high, it will slow down the fast signals edges, and conversely, if its value is too small, it won't be able to hold a constant change between the first bit and the last bit of a long string of identical bits in a low data rate application. This leads to higher pattern-dependent jitter in the transmitter signal. $0.1\mu F$ is found to be good for all applications from 155Mbps to 1.25Gbps.

AC-coupling the laser to the driver brings a solution to the driver headroom problem at the expense of extra components, loss of part of the modulation current wasted in the pull-up network, and additional power consumption.

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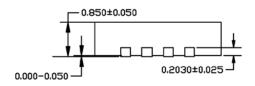
Package Information and Recommended Land Pattern⁽¹⁰⁾





TOP VIEW NOTE: 1, 2, 3

BOTTOM VIEW NOTE: 1, 2, 3



SIDE VIEW NOTE: 1, 2, 3

NOTE:

- 1. MAX PACKAGE WARPAGE IS 0.05 MM 2. MAX ALLOWABLE BURR IS 0.076 MM IN ALL DIRECTIONS
- 3. PIN #1 IS ON TOP WILL BE LASER MARKED
- 4. RED CIRCLE IN LAND PATTERN INDICATE THERMAL VIA. SIZE SHOULD BE 0.30-0.35 IN DIAMETER AND SHOULD BE CONNECTED TO GND FOR MAX THERMAL PERFORMANCE 5. GREEN RECTANGLES (SHADED AREA) INDICATE SOLDER STENCIL OPENING ON EXPOSED SIZE SHOULD BE 0.30-0.35 MM
- SIZE SHOULD BE 0.60×0.60 MM IN SIZE, 0.20 MM SPACING.

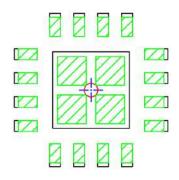
16-Pin (3mm × 3mm) QFN (QFN-16)

Note:

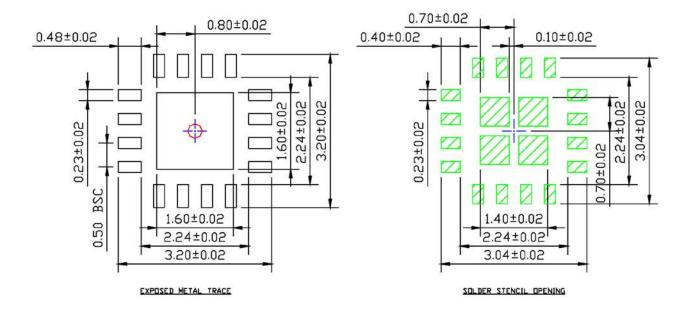
10. Package information is correct as of the publication date. For updates and most current information, go to www.micrel.com.

Package Information and Recommended Land Pattern⁽¹⁰⁾ (Continued)

RECOMMENDED LAND PATTERN NOTE: 4, 5



STACKED-UP



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